## NSN 5962-01-330-0699



Memory Microcircuit - Page 1 of 1 View Online at https://aerobasegroup.com/nsn/5962-01-330-0699 **Body Length:** Between 0.442 inches and 0.458 inches **Body Width:** Between 0.442 inches and 0.458 inches **Body Height:** Between 0.074 inches and 0.086 inches **Maximum Power Dissipation Rating:** 1.0 watts **Operating Tempurature Range:** -55.0/+125.0 degrees celsius **Storage Tempurature Range:** -65.0/+150.0 degrees celsius **Features Provided:** Monolithic and high performance and high speed **Inclosure Material:** Ceramic **Inclosure Configuration:** Leadless flat pack **Output Logic Form:** Complementary-metal oxide-semiconductor logic **Input Circuit Pattern:** 22 input **Terminal Surface Treatment:** Solder Voltage Rating And Type Per Characteristic: 7.0 volts power source **Memory Device Type:** Ram **Terminal Type And Quantity:** 28 leadless Shelf Life: N/a **Unit Of Measure:** 

--Demilitarization:

Yes - demil/mli

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